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LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

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SMD LED LTSA-E67RVAWT

1. Description

SMD LEDs from Lite-On are available in miniature sizes and special configurations for automated PC board assembly and space-sensitive applications. These SMD LEDs are suitable for use in a wide variety of electronic equipment, including cordless and cellular phones, notebook computers, network systems etc.

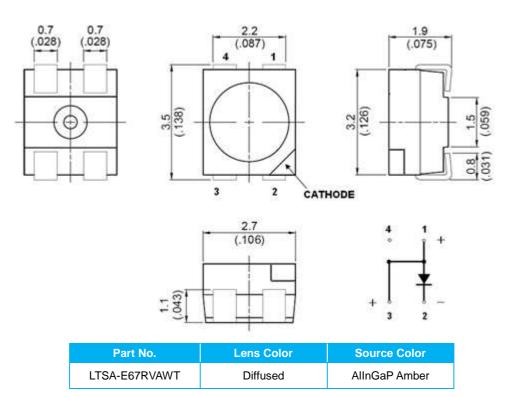
1.1 Features

- Meet ROHS
- Package in 8mm tape on 7" diameter reels
- EIA STD package
- I.C. compatible
- Compatible with automatic placement equipment
- Compatible with infrared reflow solder process
- Preconditioning: accelerate to JEDEC level 3

2. Package Dimensions



Automotive: accessary applications,



Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.2 mm (.008") unless otherwise noted.

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3. Rating and Characteristics

3.1 Absolute Maximum Ratings at Ta=25℃

Parameter	LTSA-E67RVAWT	Unit	
Power Dissipation	175	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA	
DC Forward Current	70	mA	
Operating Temperature Range	-40℃ to +100℃		
Storage Temperature Range	-40℃ to + 100℃		
Infrared Soldering Condition	260 $^\circ \! \mathbb{C}$ For 10 Seconds		

3.2 Thermal Characteristics

Parameter	Symbol	TYP.	MAX.	Unit
Thermal Resistance (Junction – Ambient) ^{Note}	Rth JA	280	-	°C /W
Thermal Resistance (Junction – Solder Point) ^{Note}	Rth Js	130	-	°C /W
Junction Temperature	TJ	-	125	°C

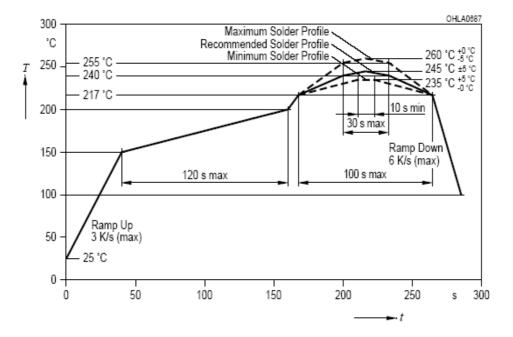
Note: Rth JA Measurement Condition

Substrate: FR4 (t=1.6mm) / Pattern Size: 16mm²



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3.3 Suggest IR Reflow Condition for Pb Free Process:



IR-Reflow Soldering Profile for lead free soldering (Acc. to J-STD-020)





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3.4 Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Part No. LTSA-	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	E67RVAWT	2800	-	4500	mcd	IF = 50mA Note 1
Viewing Angle	2 0 _{1/2}	E67RVAWT	-	120	-	deg	Note 2 (Fig.2)
Peak Emission Wavelength	λΡ	E67RVAWT	-	614	-	nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	E67RVAWT	612	-	624	nm	IF = 50mA Note 3
Spectral Line Half-Width	Δλ	E67RVAWT	-	20	-	nm	
Forward Voltage	VF	E67RVAWT	2.05	-	2.50	V	IF = 50mA Note 4
Reverse Current	IR	E67RVAWT	-	-	10	μA	VR =5V Note 5

Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve
- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device. Dominate Wavelength Tolerance is +/- 1nm.
- 4. Forward Voltage Tolerance is +/- 0.1 volt.
- 5. Reverse voltage (VR) condition is applied to IR test only. The device is not designed for reverse operation.



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4. Bin Rank

Batch Description on Label: Vf / Iv / Wd (Ex. D / Y2 / 2)

Vf Rank

Forward Volt	age (Vf) Un	Unit : V @50mA		
Bin Code	Min.	Max.		
D	2.05	2.20		
E	2.20	2.35		
F	2.35	2.50		

Tolerance on each Voltage bin is +/-0.1V

Iv Rank

Luminous Inter	nsity (Iv) Uni	Unit : mcd @50mA		
Bin Code	Min.	Max.		
Y1	2800	3550		
Y2	3550	4500		

Tolerance on each Intensity bin is +/-11%

Wd Rank

Luminous Intensity (Iv) Unit		t : mcd @50mA
Bin Code	Min.	Max.
2	612	616
3	616	620
4	620	624

Tolerance on each Wavelength bin is +/-1nm

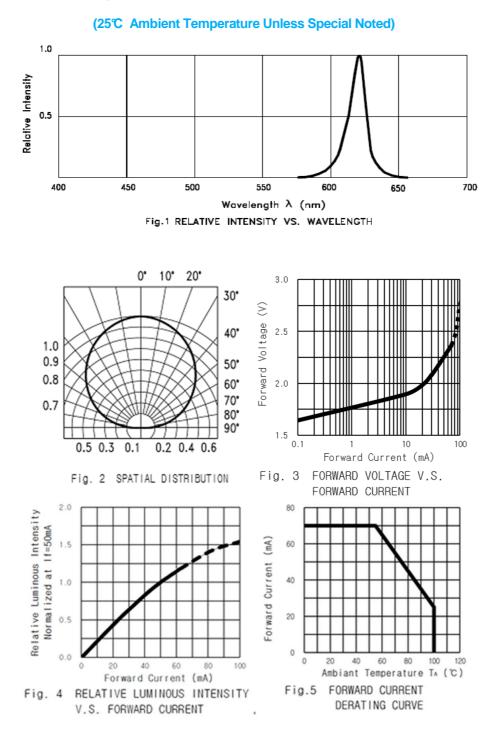
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5. Typical Electrical / Optical Characteristics Curves.



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6. User Guide

6.1 Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package. If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less one minute.

6.2 Recommend Printed Circuit Board Attachment Pad

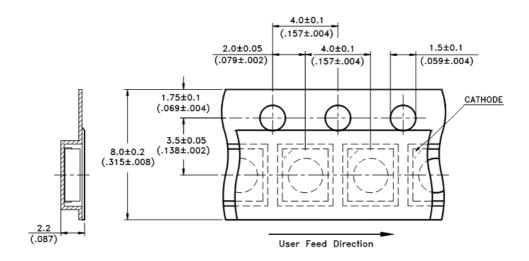
Reflow Soldering

Infrared

· ANODE for the other three pads

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6.3 Package Dimensions of Tape And Reel



Note:

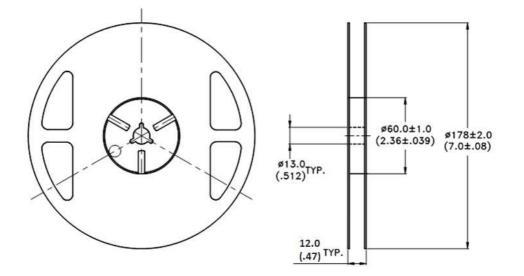
1. All dimensions are in millimeters (inches).

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6.4 Package Dimensions of Reel



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel 2000 pieces per reel.
- 3. The maximum number of consecutive missing lamps is two.
- 4. In accordance with ANSI/EIA 481 specifications.





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7. Cautions

7.1 Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications).Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

7.2 Storage

The package is sealed:

The LEDs should be stored at 30°C or less and 70%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The storage ambient for the LEDs should not exceed 30°C temperature and 60% relative humidity.

It is recommended that LEDs out of their original packaging are IR-reflowed within 168hrs.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient.

LEDs stored out of their original packaging for more than 168hrs should be baked at about 60 $^{\circ}$ C for at least 48 hours before solder assembly.

7.3 Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

7.4 Soldering

Recommended soldering conditions:

Reflow soldering		Soldering iron		
Pre-heat	150~200°C	Temperature	300℃ Max.	
Pre-heat time	120 sec. Max.	Soldering time	3 sec. Max.	
Peak temperature	260℃ Max.		(one time only)	
Soldering time	10 sec. Max. (Max. two times)			

Notes:

Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization.

LITE-ON Runs both component-level verification using in-house **KYRAMX98** reflow chambers and board-level assembly. The results of this testing are verified through post-reflow reliability testing.Profiles used at LITE-ON are based on JEDEC standards to ensure that all packages can be successfully and reliably surface mounted.

Figure on page3 shows a sample temperature profile compliant to JEDEC standards. You can use this example as a generic target to set up your reflow process. You should adhere to the JEDEC profile limits as well as specifications and recommendations from the solder paste manufacturer to avoid damaging the device and create a reliable solder joint.

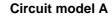


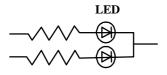


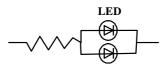
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7.5 Drive Method

A LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.







Circuit model B

- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

7.6 ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "lightup " and Vf of the suspect LEDs at low currents.

The Vf of " good " LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.





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8. Reliability Test

No.	Test item	Test condition	Sample size	Reference standard
1	Pre-conditioning	MSL 3 125℃, 24 hrs baking Moisture Soak 60℃/60% 52 hrs Interval: 15mins ~ 4 hours to do IR-Reflow	150	JESD22 A-113
2	High Temperature Operating Life I	IF=70mA, Ta=55℃, 1000 hrs	30	JESD22 A-108
3	High Temperature Operating Life II	Ta=100℃., IF=25mA, 1000 hrs	30	JESD22 A-108
4	High Temperature High Humidity Bias (HTHHB)	Ta=60℃, Rh=90%, IF=65mA, 1000 hrs	30	JESD22 A-101
5	Temperature Cycle I	-40°C ± 5°C ~ 100 ± 5°C 30min 30min Transfer time <= 1min, 500cycles	30	JESD22 A-104
6	Temperature Cycle II	-40℃~25℃~100℃~25℃ 30min 5min 30min 5min 500cycles	30	JESD22 A-104
7	Resistance to soldering heat	SMD: The moisture sensitivity level of products refers data sheet & IPC/JEDEC J-STD-020. For example: Level 3 (1) Bake 125°C / 24 hours (2) Acceleration moisture soak condition (if urgent): 60°C / 60% / 52 hours (Interval: 15mins ~ 4 hours to do IR-Reflow) (3) IR Reflow 3 times (260°C: 10 secs, Interval: 5 mins ~ 60 mins for each reflow)	30	JESD22 A-111
8	Solderability	Tsld=245± 5℃, 5 secs	11	J-STD-002 JESD22B102



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9. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

10. Suggested Checking List

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wears wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date?

Note: *50V for InGaN LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycles?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?